



## 30V P-Channel Trench Power MOSFET

### General Description

The SJM30P055 uses advanced trench technology to provide excellent  $R_{DS(ON)}$ , low gate charge and operation with gate voltages as low as -4.5V. This device is suitable for use as a wide variety of applications.

### Features

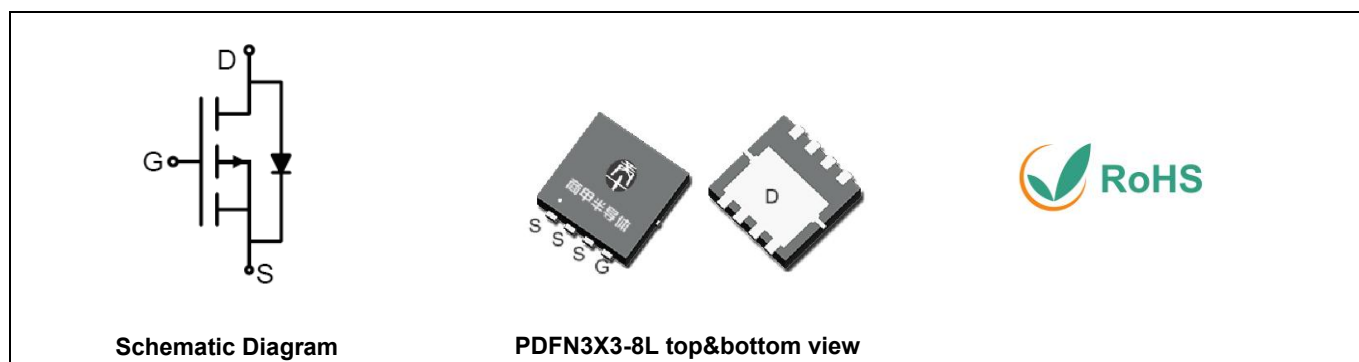
- Low Gate Charge
- High Power and current handing capability
- Lead free product is acquired

### Application

- PWM Applications
- Load Switch
- Power Management

### Key Performance Parametes

Parameter	Value	Unit
$V_{DS}$	-30	V
$R_{DS(ON\_TYP)}$	6.5	m $\Omega$
$I_D$	-60	A
$Q_G$	38	nC



### Package Marking and Ordering Information

Device/Ordering Code	Marking	Package	Packing	Reel Size	Tape width	Quantity
SJM30P055	30P055	PDFN3X3-8L	Tape	\	\	5000 Pcs

**Table 1. Absolute Maximum Ratings ( $T_C=25^\circ\text{C}$  unless otherwise noted)**

Symbol	Parameter	Limit	Unit
$V_{DS}$	Drain-Source Voltage ( $V_{GS}=0V$ )	-30	V
$V_{GS}$	Gate-Source Voltage ( $V_{DS}=0V$ )	$\pm 20$	V
$I_D$	Drain Current-Continuous( $T_C=25^\circ\text{C}$ )	-60	A
	Drain Current-Continuous( $T_C=100^\circ\text{C}$ )	-38	A
$I_{DM}$ (pluse)	Drain Current-Continuous@ Current-Pulsed (Note 1)	-240	A
$P_D$	Maximum Power Dissipation( $T_C=25^\circ\text{C}$ )	46	W
	Maximum Power Dissipation( $T_C=100^\circ\text{C}$ )	18	W
$E_{AS}$	Avalanche energy (Note 2)	289	mJ
$T_J, T_{STG}$	Operating Junction and Storage Temperature Range	-55 To 150	$^\circ\text{C}$

**Table 2. Thermal Characteristic**

Symbol	Parameter	Typ	Max	Unit
$R_{\theta JC}$	Thermal Resistance, Junction-to- Case		2.72	$^\circ\text{C/W}$



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**Table 3. Electrical Characteristics ( $T_J=25^\circ\text{C}$  unless otherwise noted)**

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
<b>On/Off States</b>						
$BV_{DSS}$	Drain-Source Breakdown Voltage	$V_{GS}=0V, I_D=-250\mu A$	-30			V
$I_{DSS}$	Zero Gate Voltage Drain Current	$V_{DS}=-30V, V_{GS}=0V, T_J=25^\circ\text{C}$			-1	$\mu A$
		$V_{DS}=-30V, V_{GS}=0V, T_J=125^\circ\text{C}$			-100	$\mu A$
$I_{GSS}$	Gate-Body Leakage Current	$V_{GS}=\pm 20V, V_{DS}=0V$			$\pm 100$	nA
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS}=V_{GS}, I_D=-250\mu A$	-1	-1.5	-2.5	V
$g_{FS}$	Forward Transconductance	$V_{DS}=-5V, I_D=-20A$		34		S
$R_{DS(ON)}$	Drain-Source On-State Resistance	$V_{GS}=-10V, I_D=-20A, T_J=25^\circ\text{C}$		6.5	8.1	m $\Omega$
$R_{DS(ON)}$	Drain-Source On-State Resistance	$V_{GS}=-4.5V, I_D=-15A, T_J=25^\circ\text{C}$		10.3	13.5	m $\Omega$
<b>Dynamic Characteristics</b>						
$C_{iss}$	Input Capacitance	$V_{DS}=-15V, V_{GS}=0V, f=1.0\text{MHz}$		3240		pF
$C_{oss}$	Output Capacitance			380		pF
$C_{rss}$	Reverse Transfer Capacitance			231		pF
<b>Switching Parameters</b>						
$t_{d(on)}$	Turn-on Delay Time	$V_{GS}=-10V, V_{DS}=-15V, R_L=0.75\Omega, R_{GEN}=3\Omega$		21		nS
$t_r$	Turn-on Rise Time			18		nS
$t_{d(off)}$	Turn-Off Delay Time			26		nS
$t_f$	Turn-Off Fall Time			8		nS
$Q_g$	Total Gate Charge	$V_{GS}=-10V, V_{DS}=-15V, I_D=-20A$		38		nC
$Q_{gs}$	Gate-Source Charge			5.5		nC
$Q_{gd}$	Gate-Drain Charge			8		nC
<b>Source-Drain Diode Characteristics</b>						
$I_{SD}$	Source-Drain Current (Body Diode)				-60	A
$V_{SD}$	Forward on Voltage (Note 3)	$V_{GS}=0V, I_S=-20A$			-1.2	V
$t_{rr}$	Reverse Recovery Time	$I_F=-10A, dI/dt=-100A/\mu s$		13		ns
$Q_{rr}$	Reverse Recovery Charge	$I_F=-10A, dI/dt=-100A/\mu s$		8		nC

Notes 1.Repetitive Rating: Pulse width limited by maximum junction temperature.

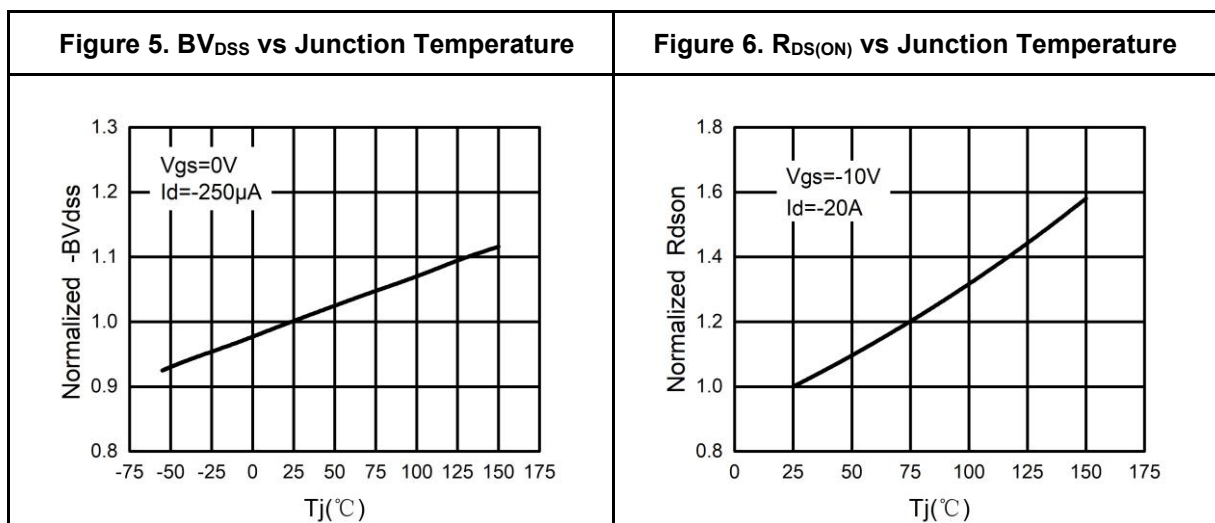
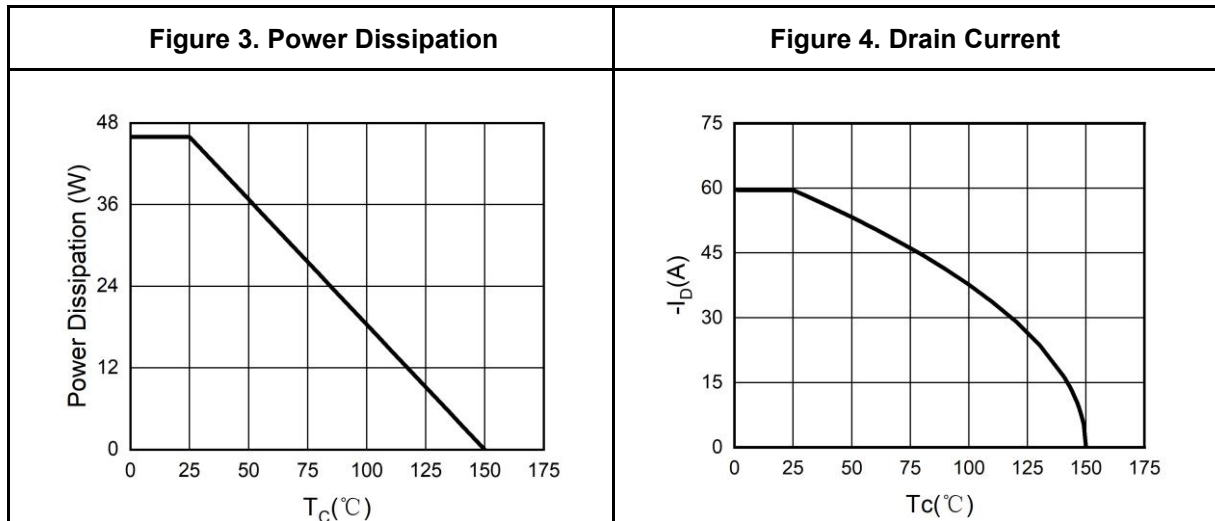
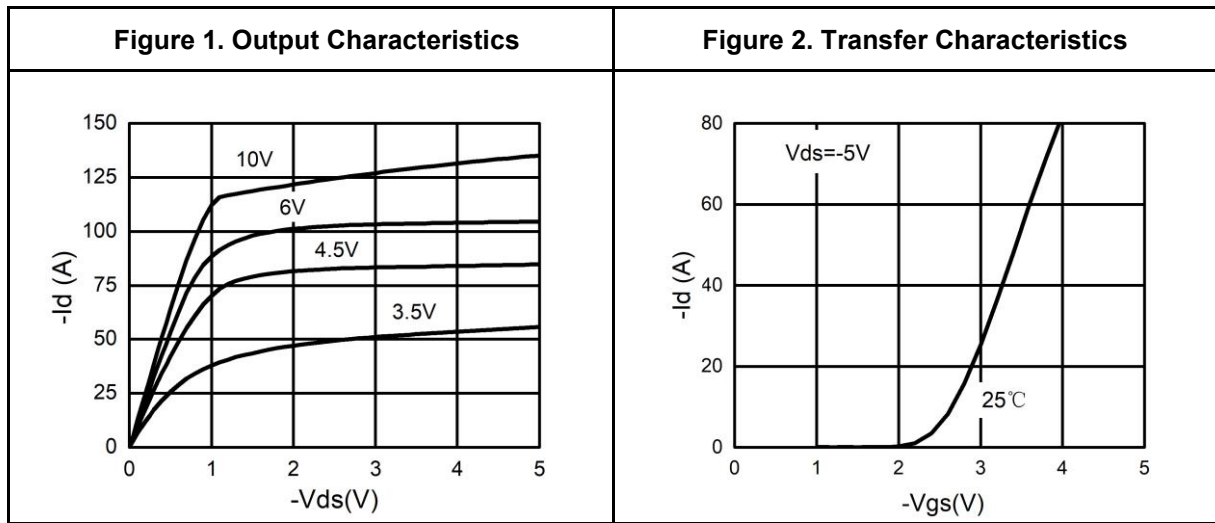
Notes 2.EAS condition:  $T_J=25^\circ\text{C}, V_{DD}=-30V, V_G=-10V, R_g=25\Omega, L=0.5\text{mH}$ .

Notes 3.Repetitive Rating: Pulse width limited by maximum junction temperature.



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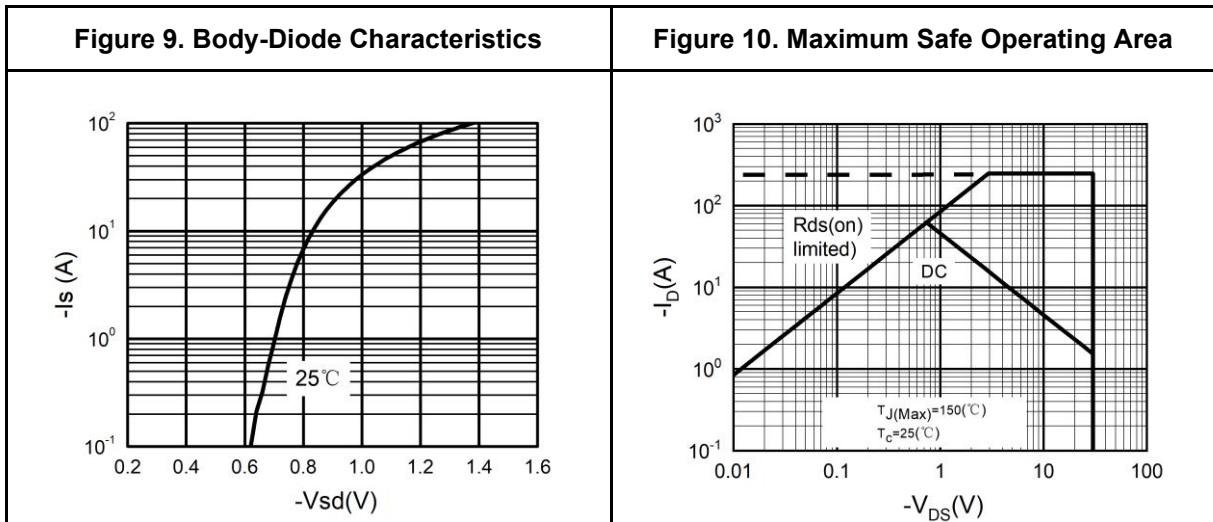
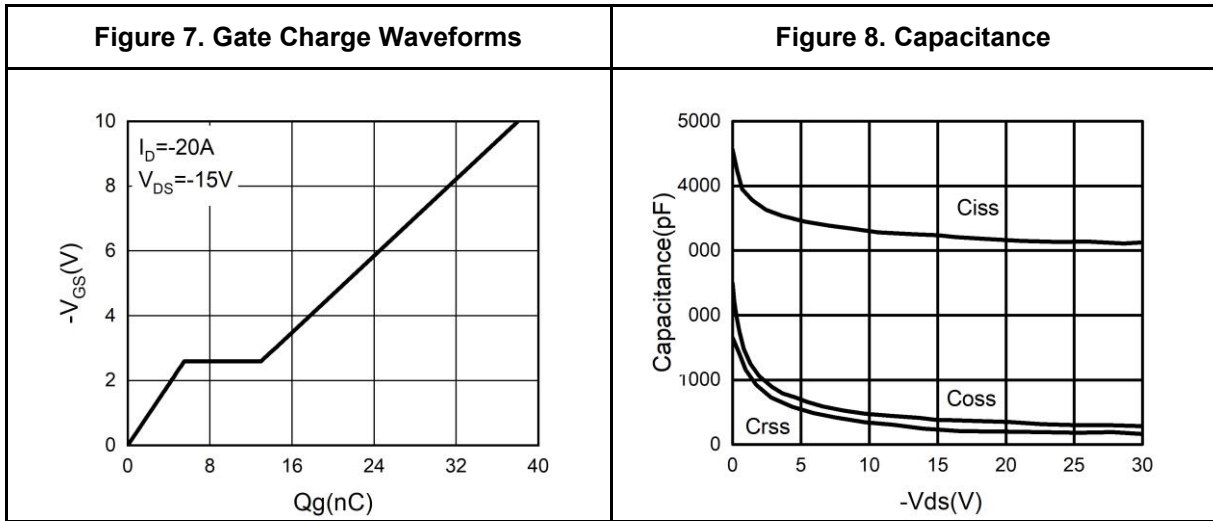
## Typical Electrical And Thermal Characteristics (Curves)





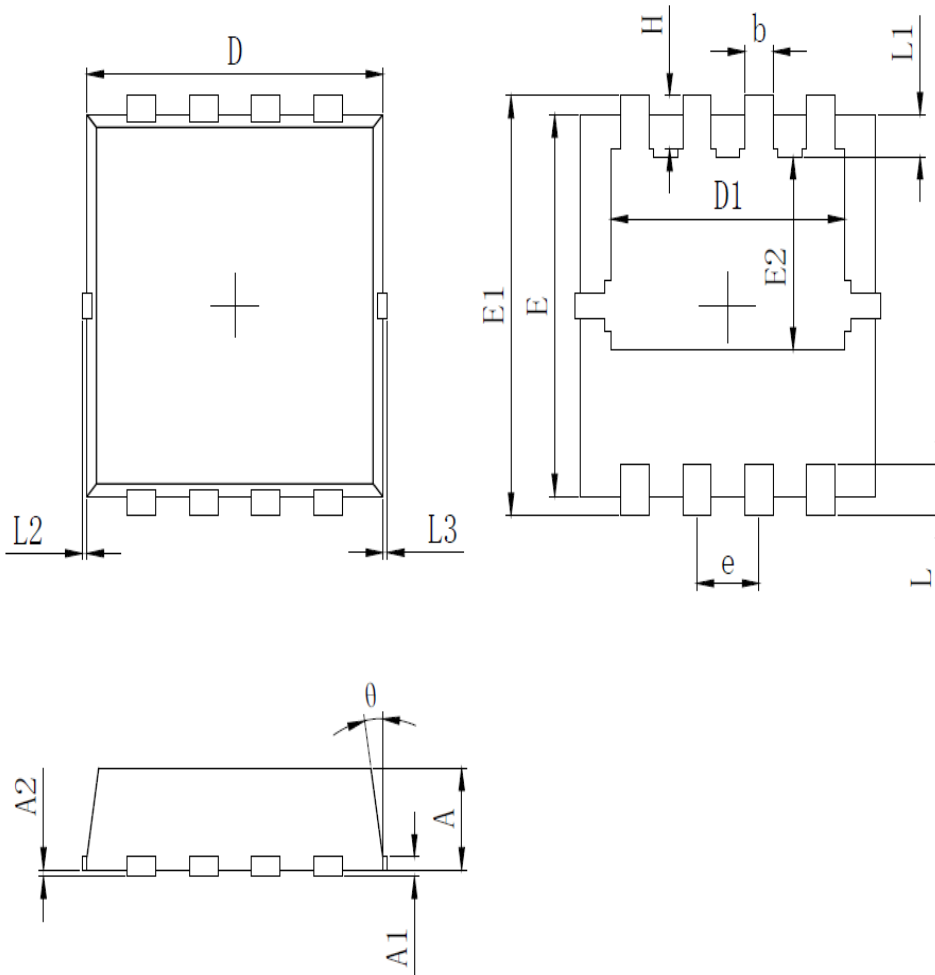
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## Typical Electrical And Thermal Characteristics (Curves)





PDFN3X3-8L Package Information



SYMBOL	MILLIMETER		
	MIN	Typ.	MAX
A	0.700	0.800	0.900
A1	0.152 REF.		
A2	0~0.05		
D	3.000	3.100	3.200
D1	2.300	2.450	2.600
E	2.900	3.000	3.100
E1	3.150	3.300	3.450
E2	1.320	1.520	1.720
b	0.200	0.300	0.400
e	0.550	0.650	0.750
L	0.300	0.400	0.500
L1	0.180	0.330	0.480
L2	0~0.100		
L3	0~0.100		
H	0.315	0.415	0.515
$\theta$	8°	10°	12°



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### Attention

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